Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

05/17/2022

Details for "SN75LBC241DWR"

Current Product Information

TI part number		Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*	
	SN75LBC241DWR	NIPDAU	Level-1-260C-UNLIM	TI TAIWAN A/T	DW 28	7.52x17.9x2.35	1082.1	

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB	
Yes	Yes	Yes	Yes	

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Iron	7439-89-6	0.000001	0.000238	2	0	0
Other Nonferrous Metals and Alloys	Calcium	7440-70-2	0.000001	0.000238	2	0	0
Other Nonferrous Metals and Alloys	Yttrium	7440-65-5	0.000003	0.000714	7	0	0
Precious Metals	Gold	7440-57-5	0.420451	99.997622	999976	0.038857	389
Precious Metals	Silver	7440-22-4	0.000005	0.001189	12	0	0
Sub-Total			0.420461	100	1000000	0.038858	389
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	1.718151	79.999991	800000	0.158786	1588
Thermoplastics	Ероху	85954-11-6	0.429538	20.000009	200000	0.039696	397
Sub-Total			2.147689	100	1000000	0.198482	1985
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	473.89515	97.05	970500	43.795777	437958
Copper and Its Alloys	Iron	7439-89-6	12.6958	2.6	26000	1.173303	11733
Copper and Its Alloys	Phosphorus	7723-14-0	0.73245	0.15	1500	0.067691	677
Zinc and Its Alloys	Zinc	7440-66-6	0.9766	0.2	2000	0.090254	903
Sub-Total			488.3	100	1000000	45.127024	451270
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	1.61704	95.12	951200	0.149441	1494
Precious Metals	Gold	7440-57-5	0.01326	0.78	7800	0.001225	12
Precious Metals	Palladium	7440-05-3	0.0697	4.1	41000	0.006441	64
Sub-Total			1.7	100	1000000	0.157108	1571
Mold Compound	•	•			•		•
Other Inorganic Materials	Fused Silica	60676-86-0	512.564362	88	880000	47.369454	473695
Other Plastics and Rubber	Carbon Black	1333-86-4	1.747379	0.3	3000	0.161487	1615
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	3.203527	0.55	5500	0.296059	2961
Thermoplastics	Ероху	85954-11-6	64.944234	11.15	111500	6.001925	60019
Sub-Total			582.459502	100	1000000	53.828925	538289
Semiconductor Device		•		•	•	•	
Ceramics / Glass	Doped Silicon	7440-21-3	7.02908	100	1000000	0.649604	6496
Sub-Total			7.02908	100	1000000	0.649604	6496
T-4-1							
Total			1082.056732			100	1000000

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component. See Glossary of Terms for more details.

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

Tibases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. Tl and Tl suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by Tl. The material content information is

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 05/17/2022

ROHS: Means TI semiconductor products that are compliant with the current ROHS requirement that the maximum concentration values of the ten substances listed in ROHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.